

2.0x1.25mm SMD CHIP LED LAMP

ATTENTION

OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** DISCHARGE SENSITIVE **DEVICES**

Part Number: KPHBM-2012QBDCGKC

Blue Green

Features

- 2.0mmx1.25mm SMT LED, 0.45mm max. thickness.
- Bi -color, low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Description

The Blue source color devices are made with InGaN Light Emitting Diode.

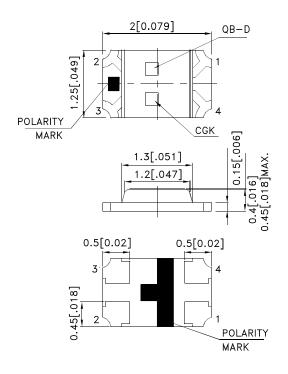
The Green source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

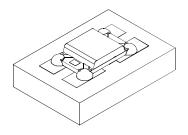
Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

Package Dimensions





- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.1(0.004") unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

 4. The device has a single mounting surface. The device must be mounted according to the specifications.

SPEC NO: DSAI9860 APPROVED: WYNEC

REV NO: V.8B CHECKED: Allen Liu

DATE: MAR/26/2013 DRAWN: Y.Liu

PAGE: 1 OF 6 ERP: 1203008819

Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
KPHBM-2012QBDCGKC	Blue (InGaN)	Water Clear	40	80	120°
	Green (AlGaInP)	Water Clear	20	50	

- Notes:

 1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

 2. Luminous intensity/ luminous Flux: +/-15%.

 3. Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Blue Green	460 574		nm	IF=20mA
λD [1]	Dominant Wavelength	Blue Green	465 570		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Blue Green	25 20		nm	I=20mA
С	Capacitance	Blue Green	100 15		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Blue Green	3.3 2.1	4 2.5	V	IF=20mA
lR	Reverse Current	Blue Green		50 10	uA	V _R = 5V

Notes:

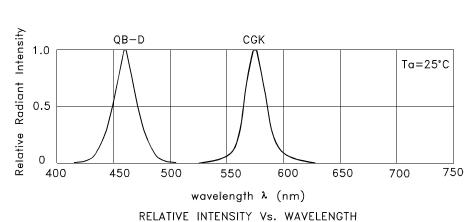
- 1.Wavelength: +/-1nm.
- Forward Voltage: +/-0.1V.
 Wavelength value is traceable to the CIE127-2007 compliant national standards.

Absolute Maximum Ratings at TA=25°C

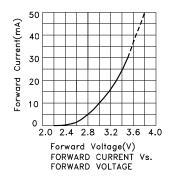
Parameter	Blue	Green	Units		
Power dissipation	ation 120 75		mW		
DC Forward Current	30	30	mA		
Peak Forward Current [1]	150	150	mA		
Reverse Voltage		V			
Operating Temperature	-40°C To +85°C				
Storage Temperature	-40°C To +85°C				

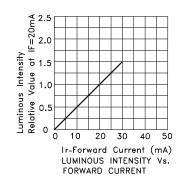
Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.

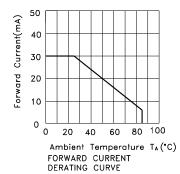
SPEC NO: DSAI9860 **REV NO: V.8B** DATE: MAR/26/2013 PAGE: 2 OF 6 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: Y.Liu ERP: 1203008819

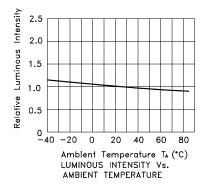


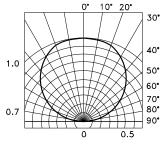
KPHBM-2012QBDCGKC Blue









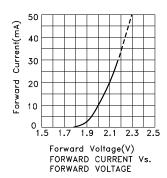


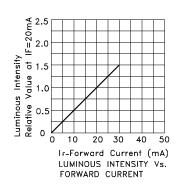
SPATIAL DISTRIBUTION

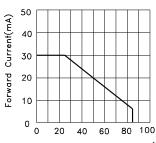
 SPEC NO: DSAI9860
 REV NO: V.8B
 DATE: MAR/26/2013
 PAGE: 3 OF 6

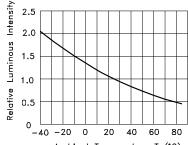
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Green







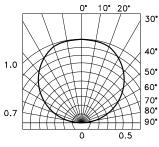






PAGE: 4 OF 6

ERP: 1203008819



SPATIAL DISTRIBUTION

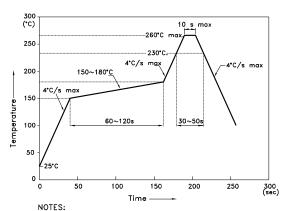
SPEC NO: DSAI9860 REV NO: V.8B DATE: MAR/26/2013

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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



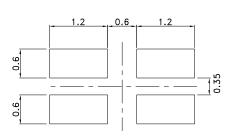
- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

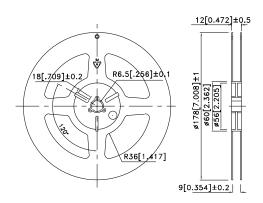
 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

 3.Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



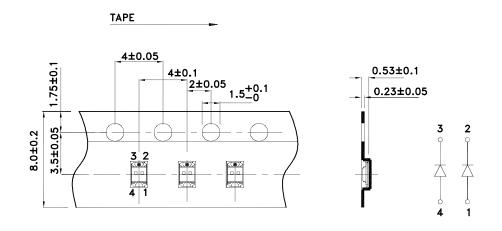
Reel Dimension



PAGE: 5 OF 6

ERP: 1203008819

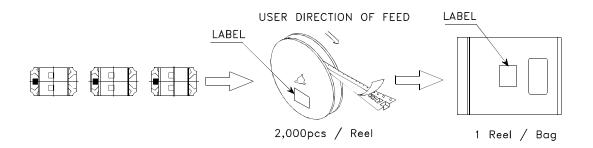
Tape Dimensions (Units : mm)

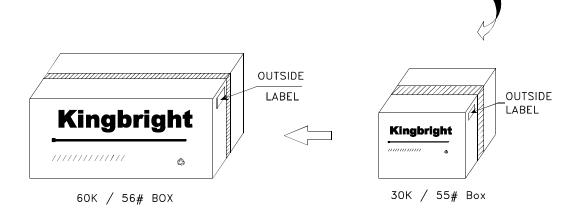


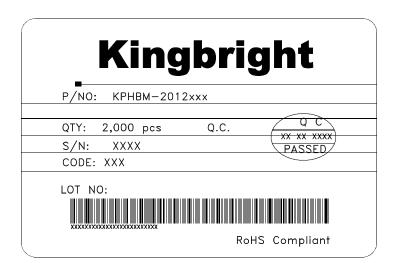
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PACKING & LABEL SPECIFICATIONS

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Detailed application notes are listed on our website. http://www.kingbright.com/application notes

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